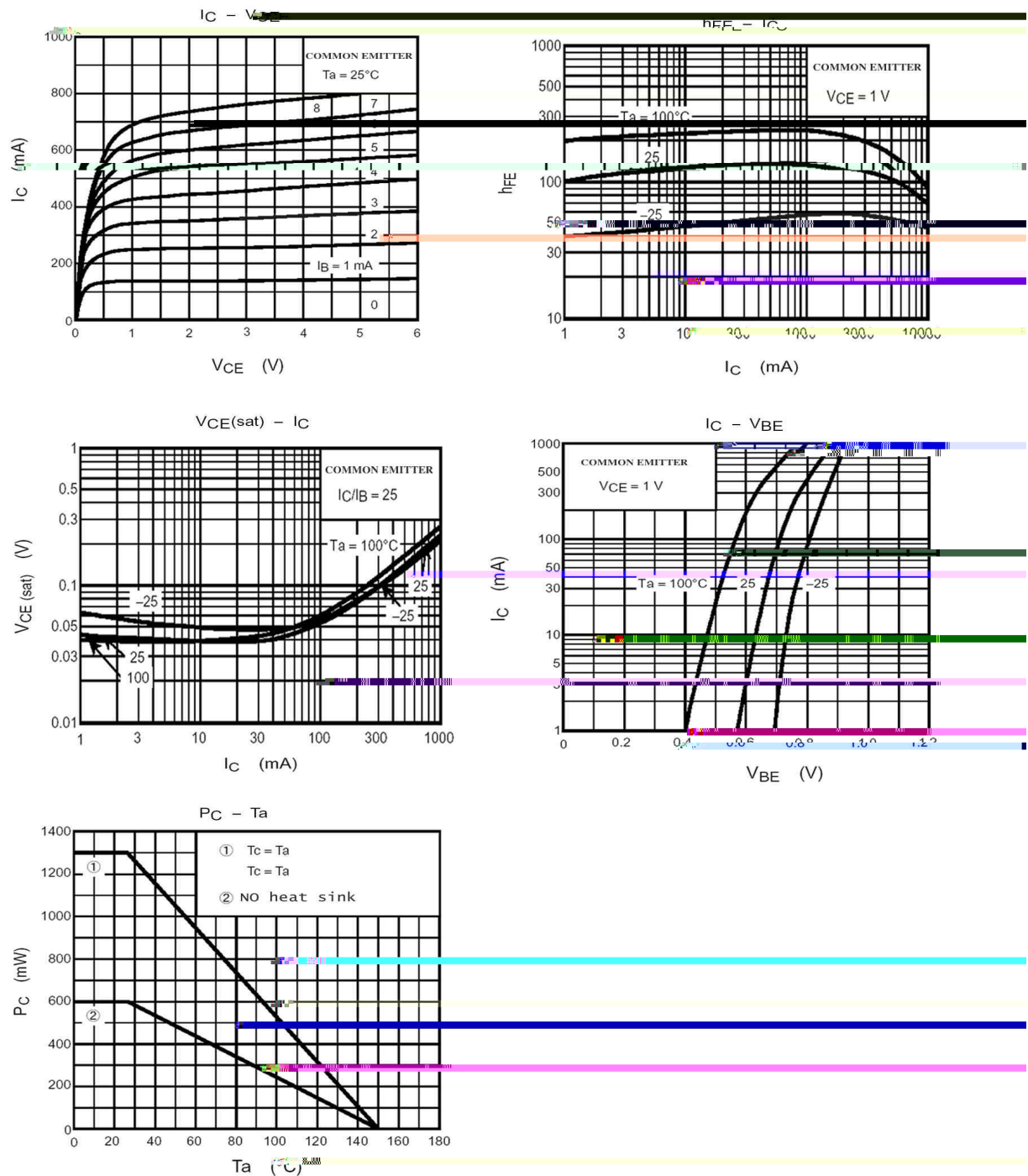


2SC2120
Rev.E Mar.-2016

Parameter	Symbol	Rating	Unit
Collector to Base Voltage	V_{CBO}	35	V
Collector to Emitter Voltage	V_{CEO}	30	V
Emitter to Base Voltage	V_{EBO}	5.0	V
Collector Current - Continuous	I_C	800	mA
Emitter Current - Continuous	I_E	-800	mA
Collector Power Dissipation	P_C	600	mW
Junction Temperature	T_J	150	
Storage Temperature Range	T_{stg}	-55 150	

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Collector to Base Breakdown Voltage	V_{CBO}	$I_C=10mA$ $I_E=0$	30			V
Collector Cut-Off Current	I_{CBO}	$V_{CB}=35V$ $I_E=0$			0.1	μA
Emitter Cut-Off Current	I_{EBO}	$V_{EB}=5.0V$ $I_C=0$			0.1	μA
DC Current Gain	$h_{FE(1)}$	$V_{CE}=1.0V$ $I_C=100mA$	100		320	
	$h_{FE(2)}$	$V_{CE}=1.0V$ $I_C=700mA$	35			

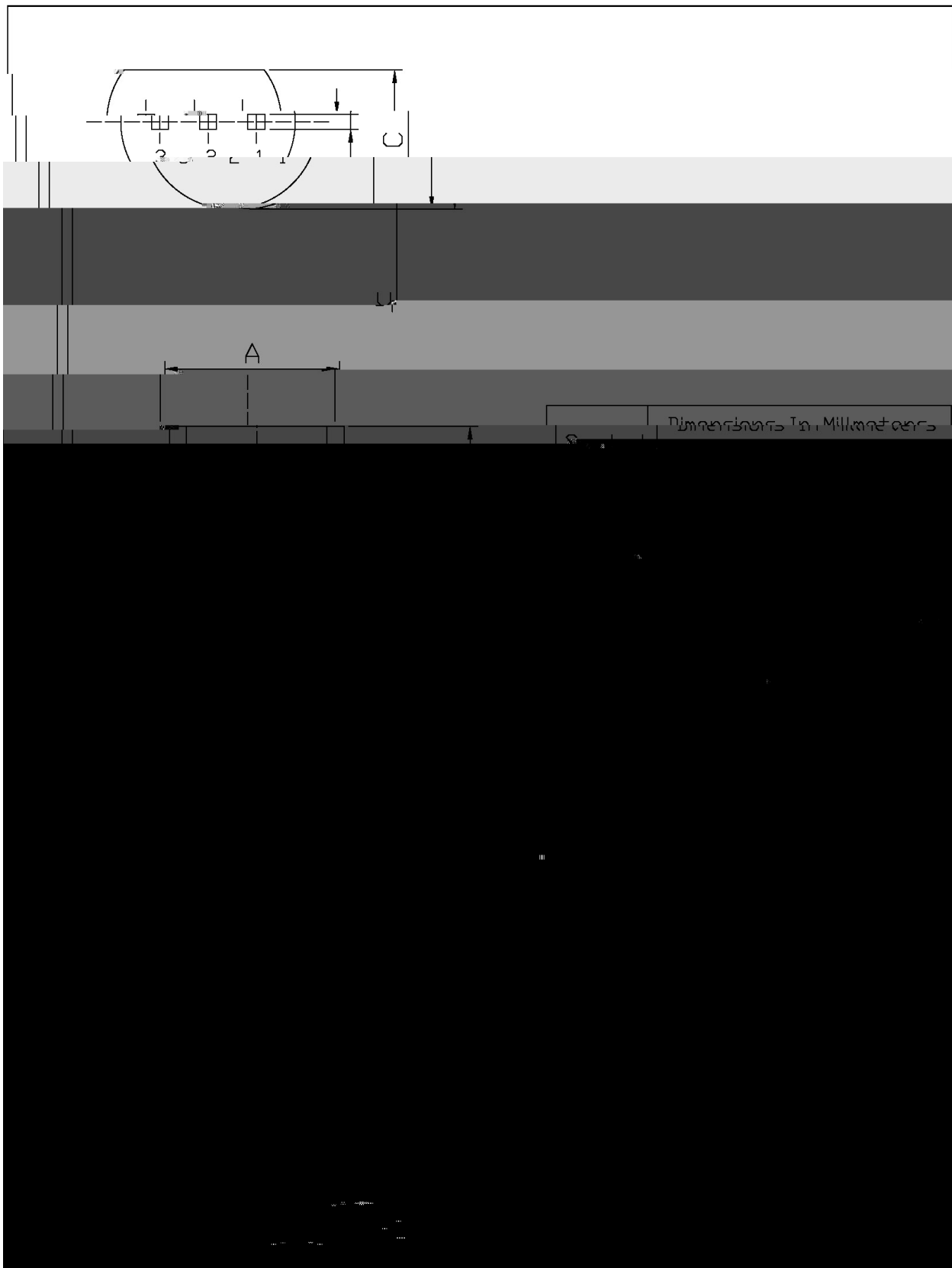
/ Electrical Characteristic Curve

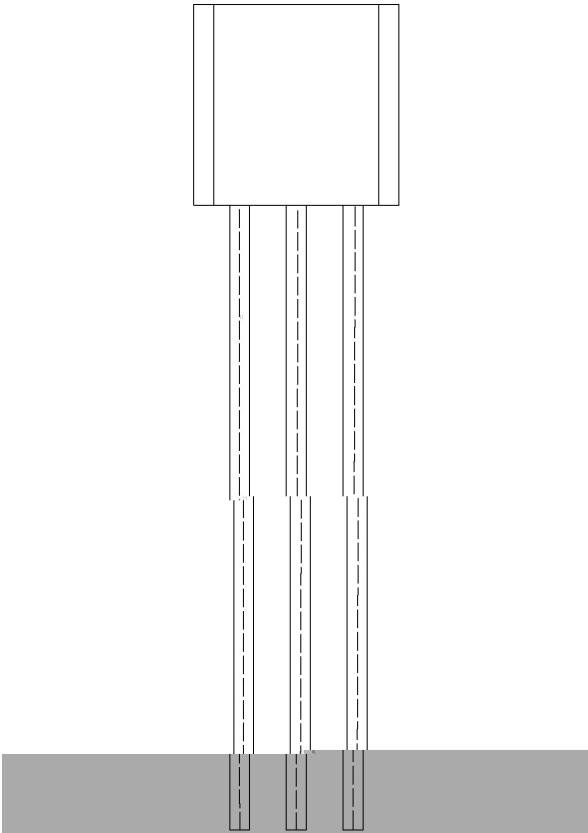


/ Package Dimensions

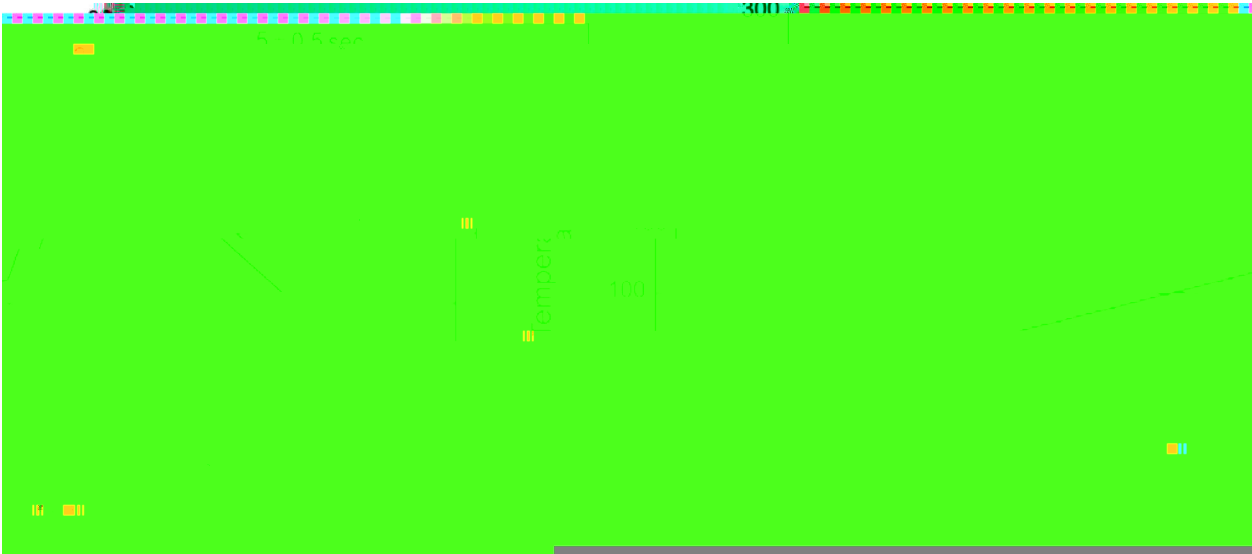
TO-92

Unit: mm





() / Temperature Profile for Dip Soldering(Pb-Free)



Note:			
1	25	150%	60 90sec;
2	255	± 5%	5 ± 0.5sec;
3		2	10%/sec.

/ Resistance to Soldering Heat Test Conditions

270 ± 5%	10 ± 1 sec.	Temp:270±5	Time:10±1 sec
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/ Packaging SPEC.

/ BULK

Package Type	Units	Dimension	(unit mm3)
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